Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

Q_{qs} (nC)

Q_{gd} (nC)

R_{DS(on)} max. (Ω)

Q_q max. (nC)

Configuration

G C

 $V_{GS} = -10 V$

P-Channel MOSFET

0.80

-200

29

5.4

15

Single

Power MOSFET

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- P-channel
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF9630PbF
Lead (Pb)-free and halogen-free	IRF9630PbF-BE3

ABSOLUTE MAXIMUM RATINGS (T _C	20 0, 0					
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	-200	- V	
Gate-source voltage			V _{GS}	± 20		
Continuous drain current	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$		-6.5	A	
		T _C = 100 °C	ID	-4.0		
Pulsed drain current ^a			I _{DM}	-26]	
Linear derating factor				0.59	W/°C	
Single pulse avalanche energy ^b			E _{AS}	500	mJ	
Repetitive avalanche current ^a			I _{AR}	-6.4 A		
Repetitive avalanche energy ^a			E _{AR}	7.4	4 mJ	
Maximum power dissipation	T _C = 25 °C		PD	74	W	
Peak diode recovery dV/dt ^c			dV/dt	-5.0	V/ns	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	*0		
Soldering recommendations (peak temperature) ^d	For 10 s			300	°C	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. $V_{DD} = -50 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 17 mH, $R_g = 25 \Omega$, $I_{AS} = -6.5 \text{ A}$ (see fig. 12)

c. $I_{SD} \leq -6.5 \text{ A}$, dI/dt $\leq 120 \text{ A}/\mu \text{s}$, $V_{DD} \leq V_{DS}$, $T_J \leq 150 \text{ °C}$

d. 1.6 mm from case

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.	TYP. MAX.		UNIT			
Maximum junction-to-ambient	R _{thJA}	- 62 0.50 - 1.7			°C/W			
Case-to-sink, flat, greased surface	R _{thCS}						°C/W	
Maximum junction-to-case (drain)	R _{thJC}							
SPECIFICATIONS ($T_J = 25 \text{ °C}$, u	inless otherw	ise noted)		- 1	1	1	•	
PARAMETER	SYMBOL	TEST	TEST CONDITIONS		TYP.	MAX.	UNIT	
Static	•				-	-		
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0$	V, I _D = -250 μA	-200	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = -1 mA	-	-0.24	-	V/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V$	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$		-	-4.0	V	
Gate-source leakage	I _{GSS}	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
		$V_{DS} = -200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	200 V, V _{GS} = 0 V	-	-	-100		
Zero gate voltage drain current	I _{DSS}	V _{DS} = -160 V,	$V_{DS} = -160 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		-	-500	μA	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = -10 V	I _D = -3.9 A ^b	-	-	0.80	Ω	
Forward transconductance	9 _{fs}	V _{DS} = -5	0 V, I _D = -3.9 A ^b	2.8	-	-	S	
Dynamic	-	+		_	<u>.</u>	<u>.</u>	<u>.</u>	
Input capacitance	C _{iss}	1	V _{GS} = 0 V, V _{DS} = -25 V, f = 1.0 MHz, see fig. 5		700	-	pF	
Output capacitance	C _{oss}				200	-		
Reverse transfer capacitance	C _{rss}	f = 1.0			40	-		
Total gate charge	Qg		I _D = -6.5 A,	-	-	29	nC	
Gate-source charge	Q _{gs}	V _{GS} = -10 V	V _{DS} = -160 V,	-	-	5.4		
Gate-drain charge	Q _{qd}		see fig. 6 and 13 ^b	-	-	15		
Turn-on delay time	t _{d(on)}			-	12	-		
Rise time	tr	- Vpp = -1	V_{DD} = -100 V, I _D = -6.5 A, R _g = 12 Ω , R _D = 15 Ω , see fig. 10 ^b		27	-	ns	
Turn-off delay time	t _{d(off)}	$R_g = 12 \Omega, R_f$			28	-		
Fall time	t _f	Ĵ.		-	24	-		
Gate input resistance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH	
Internal drain inductance	L _S			-	7.5	-		
Internal source inductance	R _g	f = 1 MHz, open drain		0.6	-	3.7	Ω	
Drain-Source Body Diode Characteristic	cs				•	•	•	
Continuous source-drain diode current	۱ _S	MOSFET symbol showing the integral reverse p -n junction diode		-	-	-6.5	A	
Pulsed diode forward current ^a	I _{SM}			-	-	-26		
Body diode voltage	V _{SD}	T _J = 25 °C, I _S	T_J = 25 °C, I_S = -6.5 A, V_{GS} = 0 V ^b		-	-6.5	V	
Body diode reverse recovery time	t _{rr}	T 25 °C I	$650 \text{ d}/\text{d} = 1000^{100}$		200	300	ns	
Body diode reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = -6.5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}^{\text{ b}}$		-	1.9	2.9	μC	
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is c			minated b	by L _S and L _D)		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

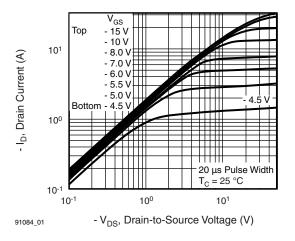


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

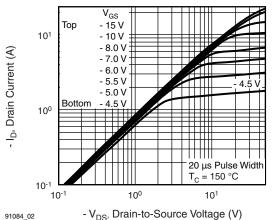


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

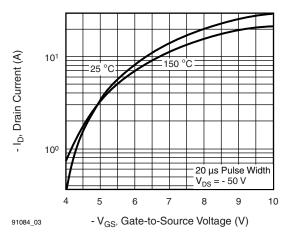


Fig. 3 - Typical Transfer Characteristics

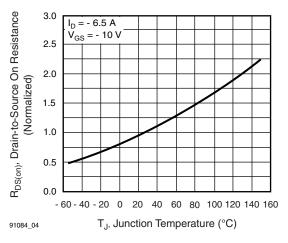


Fig. 4 - Normalized On-Resistance vs. Temperature

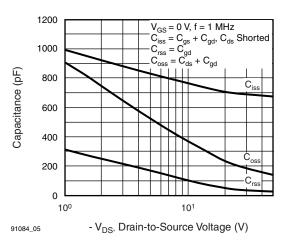


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

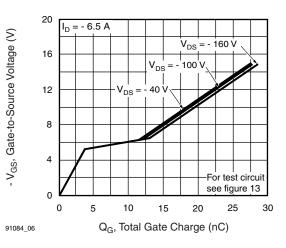


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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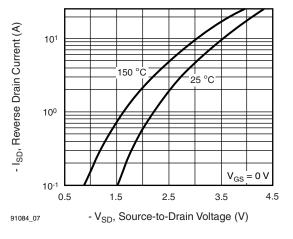


Fig. 7 - Typical Source-Drain Diode Forward Voltage

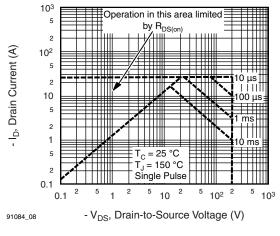


Fig. 8 - Maximum Safe Operating Area

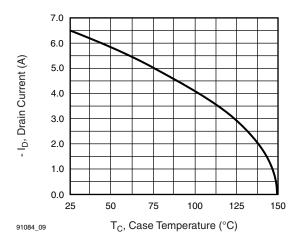


Fig. 9 - Maximum Drain Current vs. Case Temperature

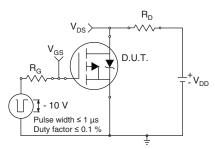


Fig. 10a - Switching Time Test Circuit

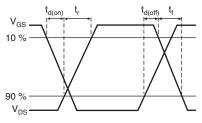


Fig. 10b - Switching Time Waveforms

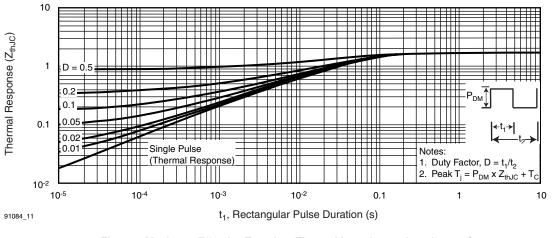


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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4 guestions, contact; hvm

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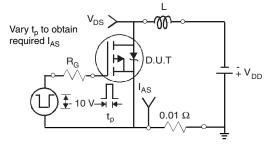


Fig. 12a - Unclamped Inductive Test Circuit

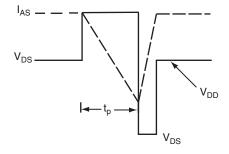


Fig. 12b - Unclamped Inductive Waveforms

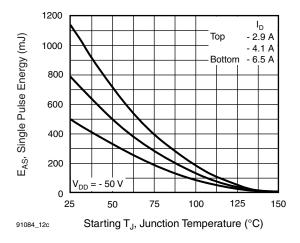


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

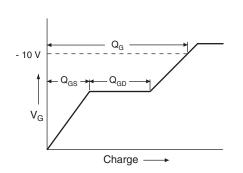


Fig. 13a - Basic Gate Charge Waveform

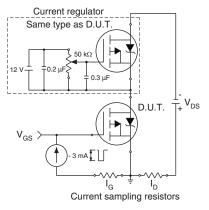


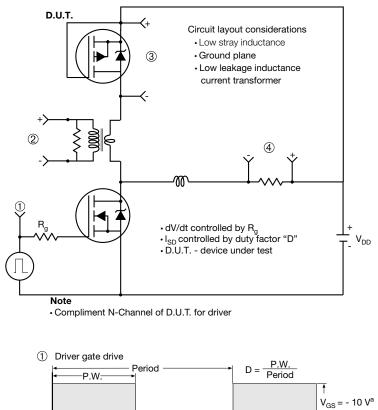
Fig. 13c - Gate Charge Test Circuit

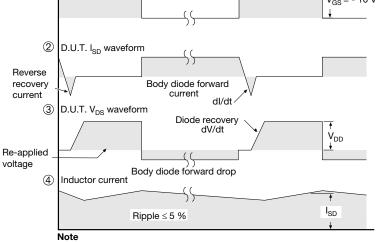


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Peak Diode Recovery dV/dt Test Circuit





a. $V_{GS} = -5$ V for logic level and -3 V drive devices

Fig. 14 - For P-Channel

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